



2017 International Symposia on
VLSI Technology, Systems and Applications
VLSI Design, Automation and Test
(2017 VLSI-TSA and DAT)

April 24-27, 2017 Hsinchu, Taiwan



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The VLSI-TSA and VLSI-DAT Symposia are the premier international events that bring together the best in device design, components technology and automation systems sciences in an environment of technical exchange and state-of-the-art innovations. The 2017 International Symposium will be synchronically held at the Ambassador Hotel Hsinchu, Taiwan, during April 24-April 27.

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